

## **High Intensity SMD LED**



#### **FEATURES**

• SMD LED with exceptional brightness



Compatible with automatic placement equipment



- EIA and ICE standard package
- Compatible with IR Reflow, vapor phase and wave solder processes according to CECC 00802 and J-STD-020C
- Available in 8 mm tape
- · Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit  $I_{Vmax}/I_{Vmin} \le 1.6$
- Lead (Pb)-free device-RoHS compliant
- · Preconditioning: acc. to JEDEC Level 2a
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B

#### **DESCRIPTION**

This device has been designed to meet the increasing demand for AllnGaP technology.

The package of the VLME31-series is the PLCC-2. It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

#### **APPLICATIONS**

- Automotive: Backlighting in dashboards and switches
- Telecommunication: Indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- · Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols
- · General use

PARTS TABLE			
PART	COLOR, LUMINOUS INTENSITY	ANGLE OF HALF INTENSITY (± φ)	TECHNOLOGY
VLME31Q2T1-GS08	Yellow, I <sub>V</sub> = (90 to 355) mcd	60°	AllnGaP on GaAs
VLME31Q2T1-GS18	Yellow, I <sub>V</sub> = (90 to 355) mcd	60°	AllnGaP on GaAs
VLME31R1S2-GS08	Yellow, I <sub>V</sub> = (112 to 280) mcd	60°	AllnGaP on GaAs
VLME31R1S2-GS18	Yellow, I <sub>V</sub> = (112 to 280) mcd	60°	AllnGaP on GaAs
VLME31S1T1-GS08	Yellow, I <sub>V</sub> = (180 to 355) mcd	60°	AllnGaP on GaAs
VLME31S1T1-GS18	Yellow, I <sub>V</sub> = (180 to 355) mcd	60°	AllnGaP on GaAs

Document Number 81324 Rev. 1.0, 09-May-06



ABSOLUTE MAXIMUM RATINGS <sup>1)</sup> , VLME31					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage <sup>2)</sup>		V <sub>R</sub>	5	V	
DC Forward current	T <sub>amb</sub> ≤ 85 °C	I <sub>F</sub>	30	mA	
Surge forward current	t <sub>p</sub> ≤ 10 μs	I <sub>FSM</sub>	0.1	A	
Power dissipation		P <sub>V</sub>	80	mW	
Junction temperature		T <sub>j</sub>	125	°C	
Operating temperature range		T <sub>amb</sub>	- 40 to + 100	°C	
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C	
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm <sup>2</sup> )	R <sub>thJA</sub>	400	K/W	

Note:

<sup>1)</sup> T<sub>amb</sub> = 25 °C, unless otherwise specified
2) Driving LED in reverse direction is suitable for short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS <sup>1)</sup> , YELLOW, VLME31							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity <sup>2)</sup>	I <sub>F</sub> = 20 mA	VLME31Q2T1	I <sub>V</sub>	90		355	
		VLME31R1S2	I <sub>V</sub>	112		280	mcd
		VLME31S1T1	I <sub>V</sub>	180		355	
Dominant wavelength	I <sub>F</sub> = 20 mA		$\lambda_{d}$	581	588	594	nm
Peak wavelength	I <sub>F</sub> = 20 mA		$\lambda_{p}$		590		nm
Angle of half intensity	I <sub>F</sub> = 20 mA		φ		± 60		deg
Forward voltage	I <sub>F</sub> = 20 mA		V <sub>F</sub>		2.0	2.6	V
Reverse voltage	I <sub>R</sub> = 10 μA		$V_{R}$	5			V
Junction capacitance	V <sub>R</sub> = 0, f = 1 MHz		C <sub>j</sub>		15		pF

Note:

LUMINOUS INTENSITY CLASSIFICATION				
GROUP	LIGHT INTENSITY [MCD]			
STANDARD	OPTIONAL	MIN	MAX	
Q	1	71	90	
	2	90	112	
R	1	112	140	
	2	140	180	
S	1	180	224	
	2	224	280	
Т	1	280	355	
	2	355	450	

#### Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

CROSSING TABLE		
VISHAY	OSRAM	
VLME31Q2T1	LYT676-Q2T1	
VLME31R1S2	LYT676-R1S2	
VLME31S1T1	LYT676-S1T1	

The second state of the second secon





COLOR CLASSIFICATION				
GROUP	YELLOW			
	DOM. WAVELENGTH [NM]			
	MIN.	MAX.		
1	581	584		
2	583	586		
3	585	588		
4	587	590		
5	589	592		
6	591	594		

#### Note:

Wavelengths are tested at a current pulse duration of 25 ms and an accuracy of  $\pm$  1 nm.

#### **TYPICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified

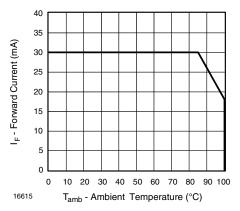


Figure 1. Forward Current vs. Ambient Temperature

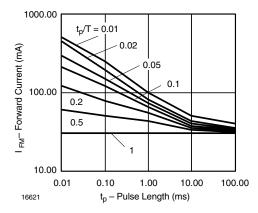


Figure 2. Forward Current vs. Pulse Length

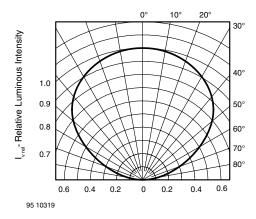


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

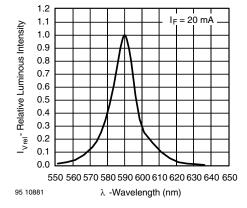


Figure 4. Relative Intensity vs. Wavelength



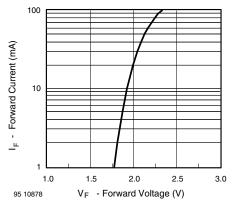


Figure 5. Forward Current vs. Forward Voltage

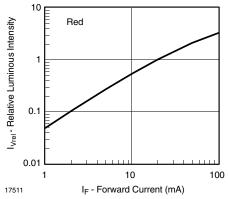


Figure 6. Relative Luminous Intensity vs. Forward Current

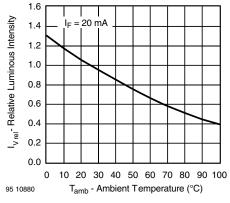


Figure 7. Rel. Luminous Intensity vs. Ambient Temperature

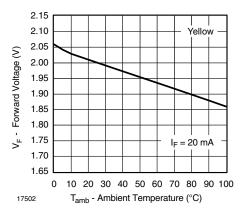


Figure 8. Forward Voltage vs. Ambient Temperature

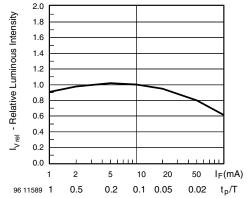
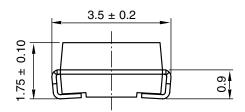


Figure 9. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle



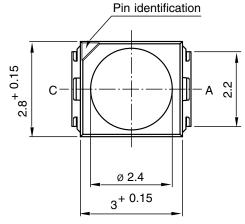


#### **PACKAGE DIMENSIONS IN MM**



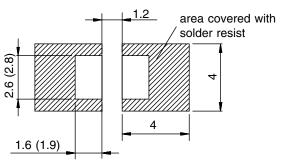


## **Mounting Pad Layout**



Drawing-No. : 6.541-5025.01-4 Issue: 8; 22.11.05

95 11314-1



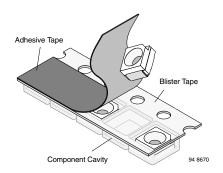
Dimensions: IR Reflow and Vaporphase (Wave Soldering)

# VISHAY.

#### METHOD OF TAPING/POLARITY AND TAPE AND REEL

#### **SMD LED (VLM3 - SERIES)**

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertation. The blister tape is a plastic strip with impressed component cavaties, covered by a top tape.



## REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

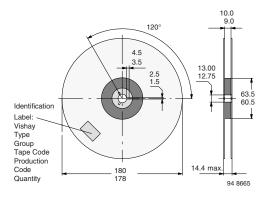


Figure 11. Reel dimensions - GS08

#### **TAPING OF VLM.3..**

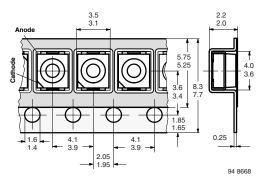


Figure 10. Tape dimensions in mm for PLCC-2

## REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERED

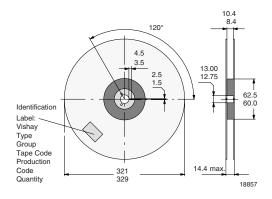


Figure 12. Reel dimensions - GS18

#### **SOLDERING PROFILE**

#### IR Reflow Soldering Profile for lead (Pb)-free soldering Preconditioning acc. to JEDEC Level 2a

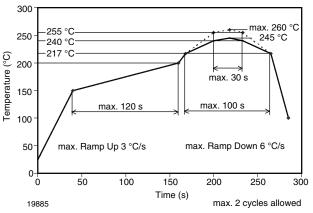


Figure 13. Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

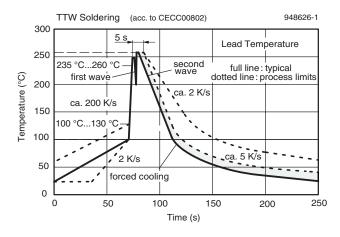
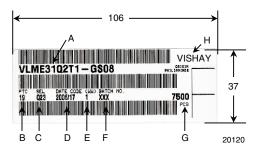


Figure 14. Double wave soldering of opto devices (all packages)

## BARCODE-PRODUCT-LABEL EXAMPLE:



- A) Type of component
- B) Manufacturing Plant
- C) SEL Selection Code (Bin):

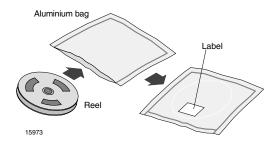
e.g.: Q2 = Code for Luminous Intensity Group

3 = Code for Color Group

- D) Date Code year/week
- E) Day Code (e.g. 1: Monday)
- F) Batch No.
- G) Total quantity
- H) Company Code

#### DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.





The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

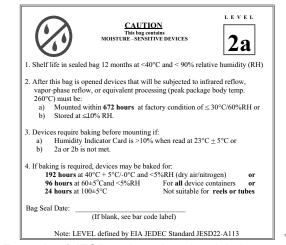
After more than 672 hours under these conditions moisture content will be too high for reflow soldering. In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 hours at 40 °C + 5 °C/ - 0 °C and < 5 % RH (dry air/nitrogen) or

96 hours at 60 °C + 5 °C and < 5 % RH for all device containers or

24 hours at 100 °C + 5 °C not suitable for reel or tubes. An EIA JEDEC Standard JESD22-A112 Level 2a label is included on all dry bags.





Example of JESD22-A112 Level 2a label

#### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Antistatic Shielding Bag. Electro-Static Sensitive Devices warning labels are on the packaging.

#### **VISHAY SEMICONDUCTORS STANDARD BAR-CODE LABELS**

The Vishay Semiconductors standard bar-code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

Document Number 81324 www.vishav.com Rev. 1.0, 09-May-06



#### **OZONE DEPLETING SUBSTANCES POLICY STATEMENT**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

## **Legal Disclaimer Notice**



Vishay

### **Notice**

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.

www.vishay.com Revision: 08-Apr-05